# プラズマ曝露によってタングステン材料中に注入されたトリチウムの挙動 Behavior of plasma-loaded tritium in tungsten materials

大塚 哲平<sup>1)</sup>、徳永 和俊<sup>2)</sup>、島田 雅<sup>3)</sup> Teppei Otsuka<sup>1)</sup>, Kazutoshi Tokunaga<sup>2)</sup>, Masashi Shimada<sup>3)</sup>

九大・総理工<sup>1)</sup>、九大・応力研<sup>2)</sup>、アイダホ国立研究所<sup>3)</sup> Kyushu Univ.<sup>1)</sup>, RIAM Kyushu Univ.<sup>2)</sup>, INL<sup>3)</sup>

## Introduction

Behavior of energetic tritium (T) implanted in plasma-facing metals is very important to understand surface modification and T retention. Recently, we have applied tritium imaging plate technique (TIPT) to measure T surface and depth profile in pure tungsten (W) after T loading by plasma at various temperatures and found that T was highly localized in near surface region within sub-mm in depth [1]. In the present study, the effect of surface modification by helium (He) irradiation on retention behavior of plasma-loaded T was examined by TIPT.

# **Experimental**

The as received sample used was stress-relieved polycrystalline pure W. The mirror-finished surface of the as-received sample was irradiated by He with energy and flux of 18.7 keV and  $\sim 10^{21}$  m<sup>-2</sup> s<sup>-1</sup> in DATS at JAEA, Japan (Hereinafter referred as He-irradiated surface). Total fluence was  $10^{24}$  m<sup>-2</sup>.

T was loaded on the He-irradiated surface and the mirror-finished surface as a reference at 473 K for 90 min by deuterium plasma including T in a linear plasma device (TPE) located at Idaho National Laboratory (INL), USA. T concentration was 0.5 After the loading, T distribution on the at%. plasma-loaded surface was measured by TIPT. Subsequently, the sample was bisected perpendicular to the plasma-loaded surface to appear a cross-section for a depth profiling of T by TIPT.

### **Results and Discussion**

Figure 1 shows distribution of plasma-loaded T at (a) the He-irradiated surface and (b) the mirror-finished surface for comparison. In the figure, surface T concentration becomes higher as the color changes from blue, green and yellow to red. The plasma-loaded area is clearly distinguished as a circle with  $\phi$  3 mm. The surface T concentration at the He-irradiated surface is much higher than that at the mirror-finished surface. As

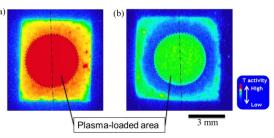


Figure 1 TIP results on (a) the He-irradiated surface and (b) the mirror-finished surface.

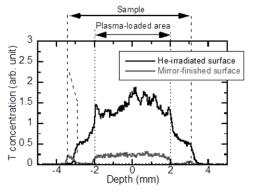


Figure 2 Surface T profile on the He-irradiated surface and the mirror-finished surface.

shown in Fig. 2, surface T profile along chain line in Fig. 1 indicates that T concentration at the surface is not He-irradiated homogeneous. surface T concentration in Averaged the plasma-loaded area at the He-irradiated surface  $(2293 \text{ PSL mm}^{-2})$  is ~7 times higher than that at the mirror-finished surface (338 PSL mm<sup>-2</sup>). The causes are attributed to larger surface area due to erosion and/or increase of hydrogen trapping site at near the surface region due to He injection. Analyzing T depth profile in the bulk of W, the effect of He irradiation on retention behavior of plasma-loaded T will be discussed.

#### References

[1] T. Otsuka, T. Tanabe, *et al.*, *J. Nucl. Mater.*, 415, S769–S772 (2011)